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May 2016



RURG1520CC

30 A, 200 V, Ultrafast Dual Diode

Feature

- Ultrafast Recovery t_{rr} = 35 ns (@ I_F = 15 A)
- Max Forward Voltage, V_F = 1.05 V (@ T_C = 25°C)
- Reverse Voltage, V_{RRM} = 200 V
- · Avalanche Energy Rated
- RoHS Compliant

Applications

- · Switching Power Supplies
- · Power Switching Circuits
- General Purpose

Ordering Informations

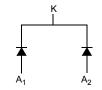
Part Number	Package	Brand
RURG1520CC	TO-247-3L	RURG1520C

Note: When ordering, use the entire part number.

Description

The RURG1520CC is an ultrafast dual diode with low forward voltage drop. This device is intended for use as freewheeling and clamping diodes in a variety of switching power supplies and other power switching applications. It is specially suited for use in switching power supplies and industrial application.





Absolute Maximum Ratings (Per Leg) T_C = 25°C

Symbol	Parameter	RURG1520CC	Unit	
V _{RRM}	Peak Repetitive Reverse Voltage	200	V	
V _{RWM}	Working Peak Reverse Voltage	200	V	
V _R	DC Blocking Voltage	200	V	
I _{F(AV)}	Average Rectified Forward Current (T _C = 157°C)	15	А	
I _{FRM}	Repetitive Peak Surge Current (Square Wave, 20 kHz)	30	Α	
I _{FSM}	Nonrepetitive Peak Surge Current (Halfwave, 1 phase, 60 Hz)	200	Α	
P _D	Maximum Power Dissipation	100	W	
E _{AVL}	Avalanche Energy (See Figures 8 and 9)	20	mJ	
T _{STG} , T _J	Operating and Storage Temperature	-65 to 175	°C	

Electrical Characteristics (Per Leg) T_C = 25°C, unless otherwise specified

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _F Forward Voltage	I _F = 15 A			1.05	V	
	I _F = 15 A, T _C = 150°C			0.85	V	
I _R Reverse Leakage	V _R = 200 V			100	μΑ	
		V _R = 200 V, T _C = 150°C			500	μΑ
t _{rr}	Reverse Recovery Time	$I_F = 1 \text{ A}, dI_F/dt = 100 \text{ A/}\mu\text{s}$			30	ns
		$I_F = 15 \text{ A}, dI_F/dt = 100 \text{ A}/\mu\text{s}$			35	ns
t _a		$I_F = 15 \text{ A}, dI_F/dt = 100 \text{ A}/\mu\text{s}$		20		ns
t _b		$I_F = 15 \text{ A}, dI_F/dt = 100 \text{ A}/\mu\text{s}$		10		ns
$R_{\theta JC}$					1.5	°C/W

DEFINITIONS

 V_F = Instantaneous forwrd voltage (pw = 300 μ s, D = 2%)

 I_R = Instantaneous reverse current.

 t_{rr} = Reverse recovery time (See Figure 6), summation of $t_a + t_b$.

t_a = Time to reach peak reverse current (See Figure 6).

t_b = Time from peak I_{RM} to projected zero crossing of I_{RM} based on a straight line from peak I_{RM} through 25% of I_{RM} (See Figure 6).

 $R_{\theta JC}$ = Thermal resistance junction to case.

pw = pulse width.

D = duty cycle

Typical Performance Curves

Figure 1. Forward Current vs Forward Voltage

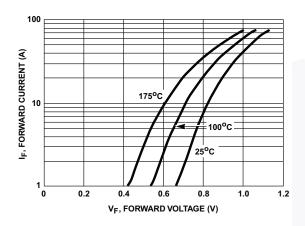


Figure 3. t_{rr}, t_a and tb Curves vs Forward Current

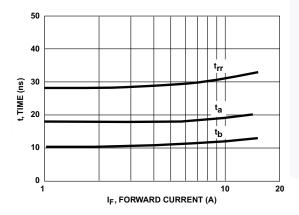


Figure 2. Reverse Current vs Reverse Voltage

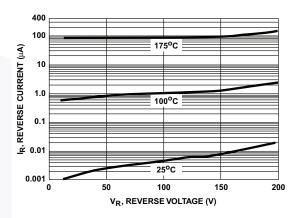
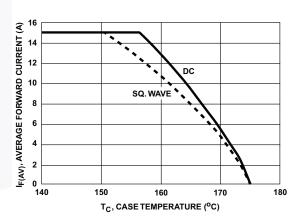


Figure 4. Current Derating Curve



Test Circuits and Waveforms

Figure 5. t_{rr} Test Circuit

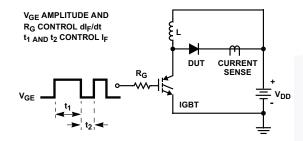


Figure 7. Avalanche Energy Test Circuit

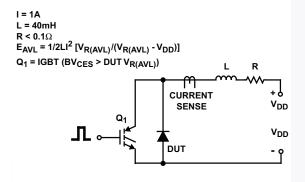


Figure 6. t_{rr} Waveforms and Definitions

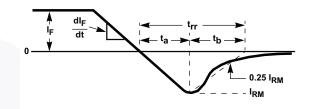
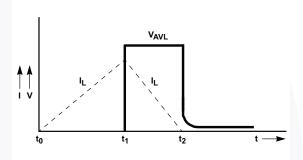
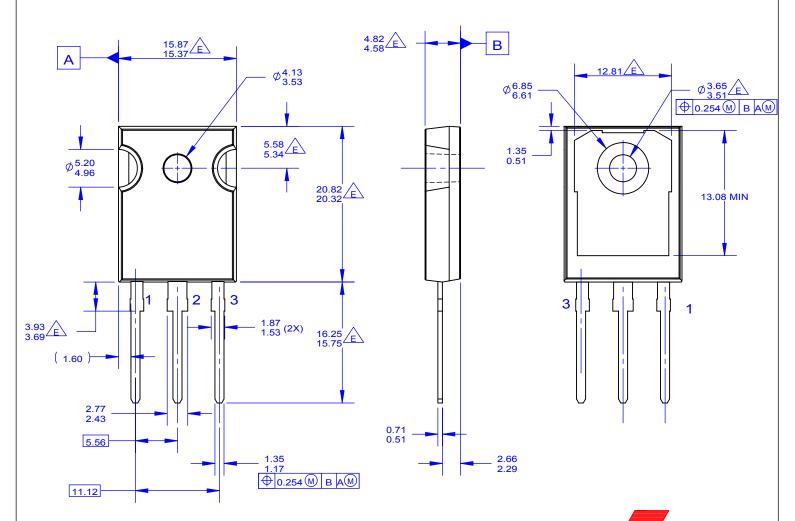


Figure 8. Avalanche Current and Voltage Waveforms







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